# MA2Q735 (MA735)

### Silicon epitaxial planar type

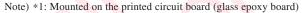
For high frequency rectification

#### ■ Features

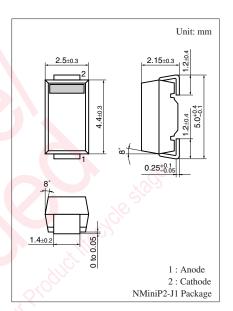
- Forward current (Average)  $I_{F(AV)} = 1$  A rectification is possible
- Reverse voltage  $V_R = 30 \text{ V}$  is guaranteed
- Automatic insertion with the emboss taping is possible

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V <sub>R</sub>	30	V
Maximum peak reverse voltage	V <sub>RM</sub>	30	V
Forward current (Average) *1	I <sub>F(AV)</sub>	1	A
Non-repetitive peak forward surge current *2	I <sub>FSM</sub>	30	A
Junction temperature	$T_{j}$	-40 to +125	°C
Storage temperature	$T_{stg}$	-40 to +125	°C ,



\*2: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

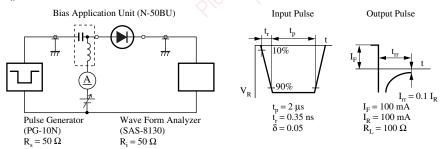


Marking Symbol: PA

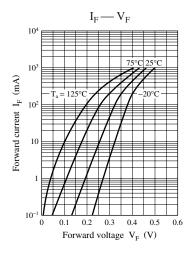
#### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

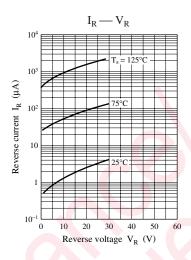
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 1.0 \text{ A}$	100	0,	0.5	V
Reverse current	$I_R$	$V_R = 30 \text{ V}$		).	1	mA
Terminal capacitance	$C_{t}$	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$	1.60	50		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$			30	ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

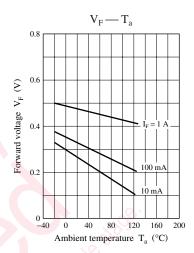
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 20 MHz.
  - 4. \*: t<sub>rr</sub> measurement circuit

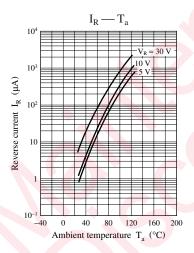


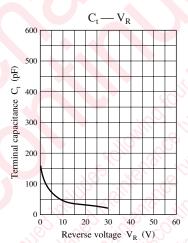
Note) The part number in the parenthesis shows conventional part number.

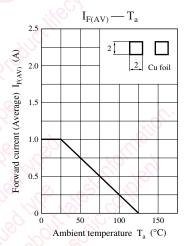












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